

20V PNP HIGH GAIN TRANSISTOR IN SOT223

Features

- $BV_{CEO} > -20V$
- $BV_{ECO} > -4V$
- I_C = 8A High Continuous Current
- Low Saturation Voltage V_{CE(sat)} < -47mV @ 1A
- $R_{CE(sat)} = 28m\Omega$
- Complementary PNP Type: ZXTN19020DG
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SOT223
- Case Material: Molded Plastic, "Green" Molding Compound;
- UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads; Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.112 grams (Approximate)

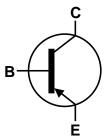
Applications

- Motor Drive
- Relay, Lamp and Solenoid Drive

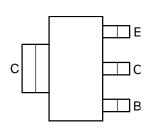




Top View



Device Symbol



Top View Pin-Out

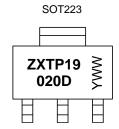
Ordering Information (Note 4)

Product	Compliance	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
ZXTP19020DGTA	AEC-Q101	ZXTP19020D	7	12	1,000

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.</p>
 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



ZXTP19020D = Product Type Marking Code YWW = Date Code Marking Y or \overline{Y} = Last Digit of Year (ex. 5= 2015) WW or $\overline{W}W = \text{Week Code } (01~53)$





Absolute Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	-25	V
Collector-Emitter Voltage	V _{CEO}	-20	V
Emitter-Collector Voltage (reverse blocking)	V _{ECO}	-4	V
Emitter-Base Voltage	V_{EBO}	-7	V
Continuous Collector Current	Ic	-8	Α
Base Current	I _B	-1	Α
Peak Pulse Current	I _{CM}	-15	Α

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
	(Note 5)		1.2 9.6		
Power Dissipation	(Note 6)		1.6 12.8	W mW/°C	
Linear Derating Factor	(Note 7)	P _D	3 24		
	(Note 8)		5.3 42		
	(Note 5)		104		
Thermal Desistance Investigate Ambient	(Note 6)		78		
Thermal Resistance, Junction to Ambient	(Note 7)	R _{θJA}	42	°C/W	
	(Note 8)		23.5		
Thermal Resistance, Junction to Lead (Note 9)		R _{0JL}	16		
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C		

ESD Ratings (Note 10)

Notes:

Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge - Machine Model	ESD MM	400	V	С

5. For a device mounted with the collector lead on 15mm x 15mm 1oz copper that is on a single-sided 1.6mm FR4 PCB; device is measured under still air

conditions whilst operating in steady-state.
6. Same as Note 6, except the device is mounted on 25mm x 25mm 1oz copper.

^{7.} Same as Note 6, except the device is mounted on 50mm x 50mm 2oz copper.

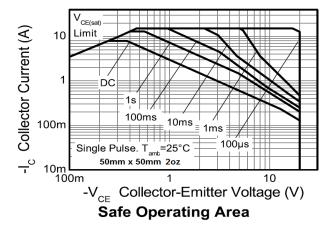
^{8.} Same as Note 8 measured at t<5 seconds.

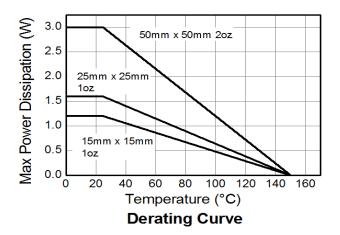
^{9.} Thermal resistance from junction to solder-point (at the end of the collector lead).

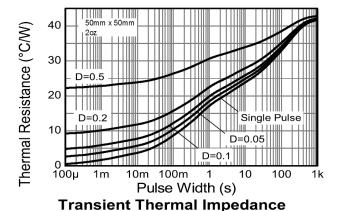
^{10.} Refer to JEDEC specification JESD22-A114 and JESD22-A115.



Thermal Characteristics and Derating Information (@T_A = +25°C, unless otherwise specified.)









Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

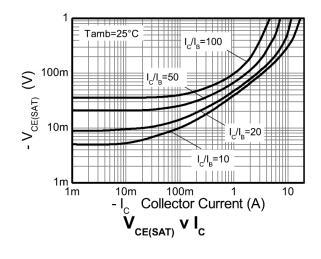
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV _{CBO}	-25	-55	-	V	$I_{C} = -100 \mu A$
Collector-Emitter Breakdown Voltage (Note 11)	BV _{CEO}	-20	-50	-	V	$I_C = -10mA$
Emitter-Collector Breakdown Voltage (reverse blocking)	BV _{ECX}	-4	-8.6	_	V	$I_C = -100\mu A$, $R_{BC} < 1k\Omega$ or 0.25V< $V_{BC} > -0.25V$
Emitter-Collector Breakdown Voltage (reverse blocking)	BV_{ECO}	-4	-8.6	-	V	I _E = -100μA
Emitter-Base Breakdown Voltage	BV _{EBO}	-7	-8.2	_	V	I _E = -100μA
Collector Cut-Off Current	1	_	< 1	-50	nA	V _{CB} = -25V
Collector Cut-Oil Current	I _{CBO}	-	-	-0.5	μA	$V_{CB} = -25V, T_A = +100^{\circ}C$
Emitter Cut-Off Current	I _{EBO}	=	< 1	-50	nA	$V_{EB} = -5.6V$
	V	_	-40	-47	mV	$I_C = -1A$, $I_B = -100mA$
Collector-Emitter Saturation Voltage (Note 11)		_	-97	-130	mV	$I_C = -1A$, $I_B = -10mA$
Collector-Emitter Saturation voltage (Note 11)	V _{CE(sat)}	_	-115	-145	mV	$I_C = -2A$, $I_B = -40mA$
		_	-220	-275	mV	$I_C = -8A$, $I_B = -800mA$
Base-Emitter Saturation Voltage (Note 11)	$V_{BE(sat)}$	=	-1050	-1150	mV	$I_C = -8A$, $I_B = -800mA$
Base-Emitter Turn-On Voltage (Note 11)	$V_{BE(on)}$	_	-930	-1000	mV	$I_C = -8A$, $V_{CE} = -2V$
		300	450	900	=	$I_C = -100 \text{mA}, V_{CE} = -2 \text{V}$
DC Current Gain (Note 11)	h	200	290	=	=	$I_C = -2A$, $V_{CE} = -2V$
DC Current Gain (Note 11)	h _{FE}	45	70	-	=	$I_C = -8A$, $V_{CE} = -2V$
		=	25	-	=	$I_C = -15A$, $V_{CE} = -2V$
Current Gain-Bandwidth Product (Note 11)	f⊤	-	176	=	MHz	$V_{CE} = -10V, I_{C} = -50mA,$ f = 50MHz
Input Capacitance (Note 11)	C_ibo	-	-	400	pF	$V_{EB} = -0.5V, f = 1MHz$
Output Capacitance (Note 11)	C_{obo}	_	36	45	pF	V _{CB} = -10V, f = 1MHz
Delay Time	t _d	-	23		ns	
Rise Time	t _r	_	18.4	_	ns	$I_C = -1A$, $V_{CC} = -10V$,
Storage Time	t _s	_	266	_	ns	$I_{B1} = -I_{B2} = -50 \text{mA}$
Fall Time	t _f	_	49.6	_	ns]

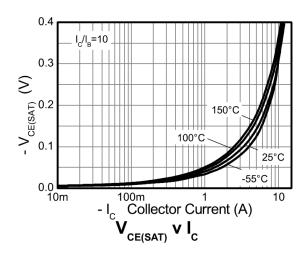
Note:

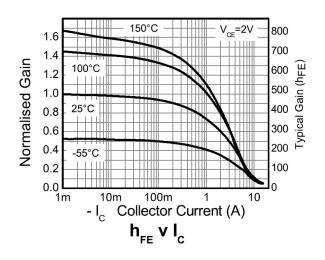
11. Measured under pulsed conditions. Pulse width \leq 300 μ s. Duty cycle \leq 2%.

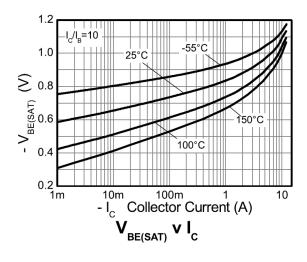


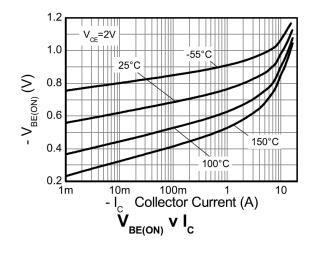
Typical Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

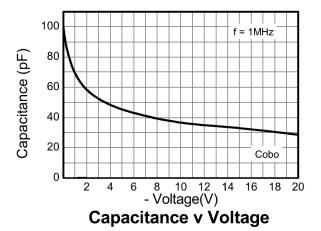








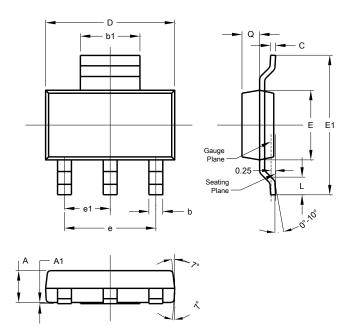






Package Outline Dimensions

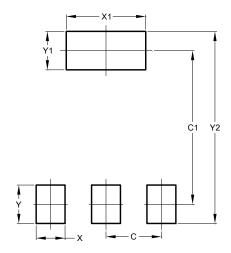
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



SOT223					
Dim	Min	Max	Тур		
Α	1.55	1.65	1.60		
A1	0.010	0.15	0.05		
b	0.60	0.80	0.70		
b1	2.90	3.10	3.00		
С	0.20	0.30	0.25		
D	6.45	6.55	6.50		
Е	3.45	3.55	3.50		
E1	6.90	7.10	7.00		
е	-	-	4.60		
e1	-	-	2.30		
L	0.85	1.05	0.95		
Q	0.84	0.94	0.89		
All Dimensions in mm					

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)		
С	2.30		
C1	6.40		
X	1.20		
X1	3.30		
Y	1.60		
Y1	1.60		
Y2	8.00		





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